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Dimensions	
Chip Size	1210
L	3.2mm +/-0.2mm
W	2.5mm +/-0.2mm
T	1.6mm +/-0.20mm
B	0.5mm +/-0.25mm

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	8000

General Information	
Series	SMD Comm X7R Tip-Ring
Style	SMD Chip
Description	SMD, MLCC, Temperature Stable, Tin Termination
Features	Tin Termination
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	85 mg
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.27 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	10%
Voltage DC	250 VDC
Dielectric Withstanding Voltage	625 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	370.4 MOhms

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